

• General Description

The AGM15T13C combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{\text{DS(ON)}}$.

This device is ideal for load switch and battery protection applications.

Features

- Advance high cell density Trench technology
- Low R_{DS(ON)} to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

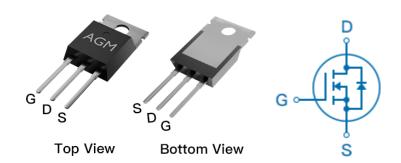
Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

BVDSS	RDSON	ID
150V	9.0mΩ	99A

TO-220 Pin Configuration



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM15T13C	AGM15T13C	TO-220			1000

Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	150	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	99	А
	Drain Current-Continuous(Tc=100℃)	70	Α
IDM (pluse)	Drain Current-Pulsed (Note 2)	396	Α
PD	Maximum Power Dissipation(Tc=25℃)	212	W
	Maximum Power Dissipation(Tc=100℃)	85	W
EAS	Avalanche energy (Note 3)	672	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}$

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹	45	56	°C/W
RθJC	Thermal Resistance Junction-Case ¹	0.45	0.59	°C/W



Table 3. Electrical Characteristics (TJ=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250µA	150			V
IDSS	Zero Gate Voltage Drain Current	VDS=150V,VGS=0V			1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	2.0		4.0	V
gFS	Forward Transconductance	VDS=5V,ID=15A		43		S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=20A		9.0	12	mΩ
Dynamic (Characteristics					
Ciss	Input Capacitance	VDS=75V,VGS=0V,		2330		pF
Coss	Output Capacitance	F=1MHZ		316		pF
Crss	Reverse Transfer Capacitance			17		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz		2.2		Ω
Switching	Times					
td(on)	Turn-on Delay Time			8.6		nS
tr	Turn-on Rise Time	VGS=10V,VDS=72V		17		nS
td(off)	Turn-Off Delay Time	ID=20A,RGEN=3Ω		28		nS
tf	Turn-Off Fall Time			22		nS
Qg	Total Gate Charge			36		nC
Qgs	Gate-Source Charge	VGS=10V, VDS=75V, ID=20A		10		nC
Qgd	Gate-Drain Charge	2071		7.7		nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)				99	Α
VSD	Forward on Voltage	VGS=0V,IS=20A			1.2	V
trr	Reverse Recovery Time	IS=20A , dI/dt=100A/μs ,		76		ns
Qrr	Reverse Recovery Charge	TJ=25℃		227		nc

Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25 $^{\circ}$ C



Typical Electrical and Thermal Characteristics

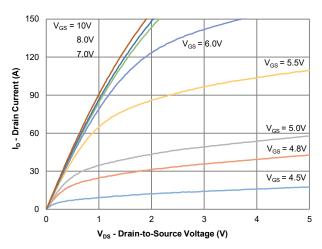


Figure 1: Output Characteristics

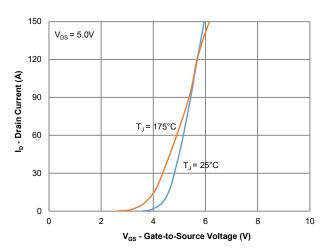


Figure 2: Transfer Characteristics

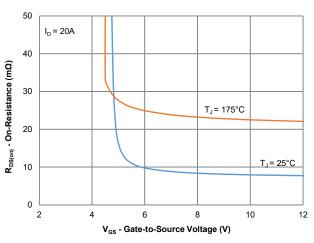


Figure 3: On-Resistance vs. Gate-Source Voltage

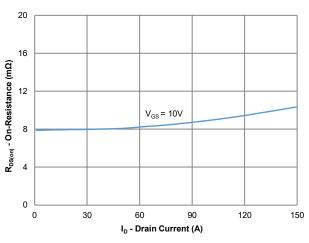


Figure 4: On-Resistance vs. Gate-Source Voltage

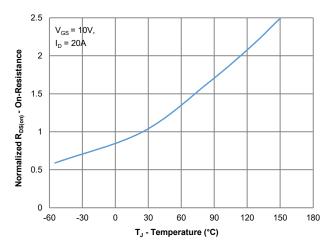


Figure 5: On-Resistance vs. Junction Temperature

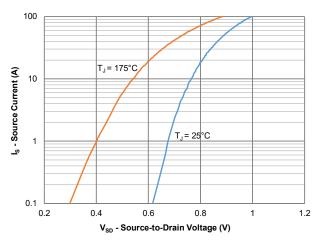


Figure 6: Source-Drain Diode Forward Voltage



Typical Electrical and Thermal Characteristics

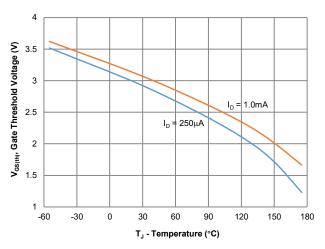


Figure 7: Gate Threshold Variation vs. Junction Temperature

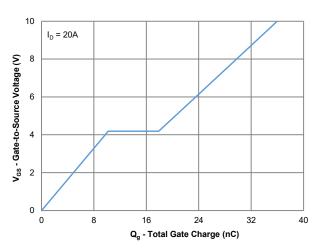


Figure 8: Gate Charge Characteristics

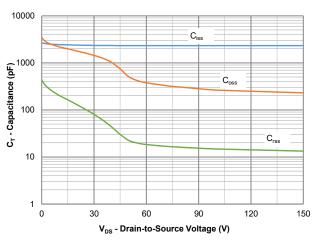


Figure 9: Capacitance Characteristics

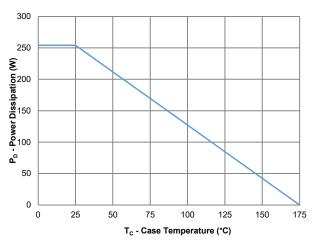


Figure 10: Power Derating

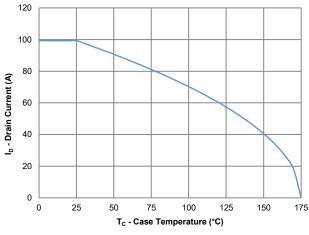


Figure 11: Current Derating

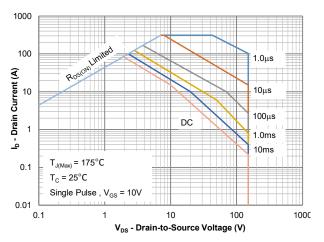


Figure 12: Safe Operating Area



Typical Electrical and Thermal Characteristics

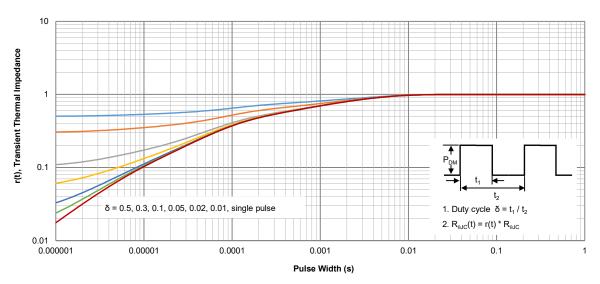
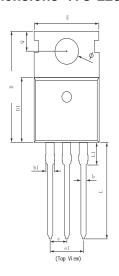
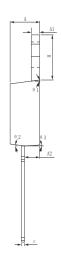


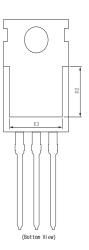
Figure 13: Normalized Maximum Transient Thermal Impedance



•Dimensions (TO-220)

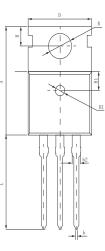


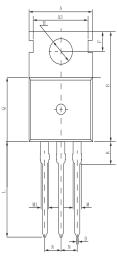




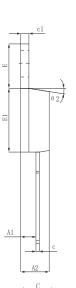
SYMBOL.	MILLIMETER		
SIMBUL	MIN	Typ.	MAX
A	4.370	4. 570	4.700
A1	1.250	1.300	1.400
A2	2.150	2. 350	2. 550
b	0.700	0.800	0.950
b1	1.170	1. 270	1.470
С	0.450	0.500	0.600
D	15. 100	15.600	16.100
D1	8.800	9.100	9.400
D2	5.500	6.300 REF	
Е	9.700	10.000	10.300
E3	7.000	7.600 REF	
е	2. 540 BSC		
e1	5. 080 BSC		
L	13. 200	13.500	13.800
L1		3. 100	3.400
Н	6.250	6. 500	1. 352
Φ	3.400	3.600	3.800
Q	2.600	2. 800	3.000
θ 1	7° TYP		
θ2	7° TYP		
θ 3	3° TYP		



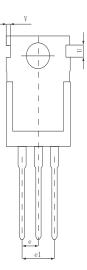


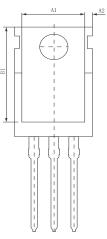












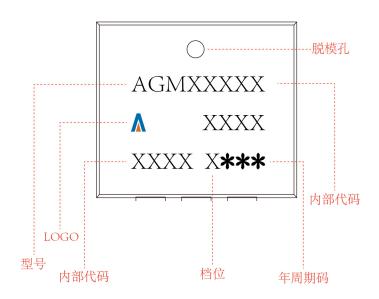
SYMBOL.		MILLIMETER	
SIMDUL	MIN	Тур.	MAX
A	15.400	15.600	15.800
A1	2. 350	2. 400	2. 500
A2	4. 400	4. 500	4. 700
b	0.700	0.800	0. 900
b2	1. 180	1. 310	1. 440
С	0.480	0.500	0.560
c1	1.290	1. 300	1. 320
D	9.800	10.000	10.200
E	6. 400	6. 500	6. 600
E1	9.000	9. 100	9. 200
е	2. 420	2.540	2.660
e1	4.840	5. 080	5. 320
Н	2. 730	2. 800	2. 870
H1	2. 400	2.500	2.600
L	13.020	13. 370	13.720
R	3.500	3.600	3. 730
R1	1.400	1.500	1.600
U	1.650	1.750	1.850
V	0. 580	0.680	0. 780
θ 1	2°	2.5°	3°
θ2	6.5°	7°	7.5°

Symbo1	Dimensions (mm)	
A	10.0±0.3	
A1	8.0±0.2	
A2	0.94±0.1	
A3	8.7±0.1	
В	15.6±0.4	
B1	13.2±0.2	
С	4.5±0.2	
C1	1.3±0.2	
D	0.8±0.2	
D1	0.5±0.1	
Е	10.0±0.3	
F	2.8±0.1	
Н	3.6 ± 0.1	
K	3.1±0.2	
L	1.3±0.4	
M	1.38±0.1	
M1	1.28±0.1	
N	2.54 (typ)	
P	2.4±0.3	
Q	9.15±0.25	

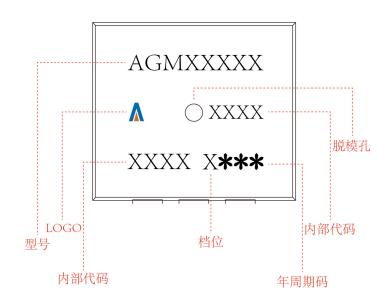


TO-220 Marking Instructions:

Model1:



Model2:





Disclaimer:

The information provided in this document is believed to be accurate and reliable. However, Shenzhen Core Control Source Electronics Technology Co., Ltd. does not assume any responsibility for the following consequences. Do not consider the use of such information or use beyond its scope.

The information mentioned in this document may be changed at any time without notice.

The products and information provided in this document do not infringe patents. Shenzhen Core Control Source Electronics Technology Co., Ltd. assumes no responsibility for any infringement of any other rights of third parties. The result of using such products and information.

This document is the seventh version issued on April 25th, 2024. This document replaces all previously provided information.

It is a registered trademark of Shenzhen Core Control Source Electronics Technology Co., Ltd.

Copyright © 2017 Shenzhen Core Control Source Electronics Technology Co., Ltd. all rights reserved.